



4M/ICOMM2015 INTERNATIONAL CONFERENCE ON MICROMANUFACTURING

Milan, Italy, 31st March - 2nd April

The 4M/ICOMM2015 Conference is jointly organized by the **International Institution for Micromanufacturing (I2M2)** and the **4M Association** bringing together the worldwide community of micromanufacturing experts. The Conference focuses on processes, equipment and systems for fabricating miniature parts with nano/micro/meso scale features and dimensions.

Themes

Papers are invited that present original research and development in processes and process chains for multi-material nano/micro/meso scale manufacture, in particular but not limited to:

- Components: fabrication technologies and process chains
- Systems: novel product designs and assembly technologies
- Process modelling and simulation
- Process characterisation including process chains
- Metrology: on-line monitoring and inspection systems/methods
- Materials: processing and characterisation of smart materials and material related issues in micro and nano scale

The Conference also features invited special sessions focused on the latest technology and application advances achieved in major international funded projects.

All papers must be technical in nature and include original work.

Selected papers will be fast tracked in following journals: ASME Journal of Micro and Nano Manufacturing (JMNM), SME Journal of Manufacturing Processes (JMP) and International Journal of Nanomanufacturing (IJNM).

Venue

Milan is a bridge to discover Italy, its culture, arts, food, fashion and wonderful natural and touristic attractions. Milan will also host Expo Milano 2015.

Conference schedule

(4 page) Full paper submission	1 st	Nov	2014
Review feedback to authors	17 th	Dec	2014
Full paper final submission	12 th	Jan	2015
Authors registration	8 th	Feb	2015

Conference Co-Chairs

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Learn more at: http://www.4m-icomm-2015.polimi.it















